



Typical Appearance

Material Content Data Sheet

Umbrella Spec	IH4B-IHM B 130 Cu						
Date	2013-10-23			RoHS compliant		no	
Revision	5.0			valid from: date code 2014-01-01			
Construction element	Material group	Materials	CAS-Nr. if applicable	Average mass [%]*	Sum [%]	Traces	Comment
chip	inorganic material	silicon	7440-21-3	0,5	0,5		
Base plate and substrate including metallisation	non noble metal	copper	7440-50-8	61,7	66,7		
	inorganic material	aluminium oxide	1344-28-1	1,1			
	non noble metal	tin	7440-31-5	2,1			
	non noble metal	lead	7439-92-1	1,7			
	non noble metal	nickel	7440-02-0			X	
	noble metal	silver	7440-22-4			X	
wire	non noble metal	aluminium	7429-90-5			X	
encapsulation	polymers	silicone gel		11,4	11,4		
housing							Containing no halogenated compounds or diantimony trioxide classifications: NF F16-101 fire & smoke: I3 / F2 CEN/TS 45545: R25: HL3 R24: HL3 R23: HL2
	polymers	Polyamid (PA)		8,0	11,6		
	inorganic material	phosphorus		0,1		X	
	inorganic material	silicondioxide / glasfiber		3,5			
lead, finish and plating	non noble metal	copper	7440-50-8	7,1	9,8		
	ferrous metal	steel	11121-90-7	2,7			
	non noble metal	zinc	7440-66-6			X	
	non noble metal	nickel	7440-02-0			X	
deviation	<25%			Sum in total	100.0		

Weight range of product	1275 g
Fluctuation margin	<25%

*) related to component weight

**) Weight of particular product, see technical product information

Important Remarks:

- 1) This document provides full declaration of all materials present in Infineon products above a threshold of 0,1 % b.w. (1000 ppm).
- 2) Trace concentrations (i.e. < 0,1 % b.w) present in products are marked with an "X" as far as they represent substances-of-concern.
A list of substances-of-concern can be found at <http://www.infineon.com/soc>.
- 3) All statements are based on our present knowledge and are subject to change at any time due to technical requirements and development.

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